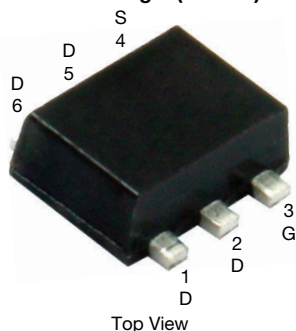


## P-Channel 30 V (D-S) MOSFET

### PRODUCT SUMMARY

| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω) MAX.      | I <sub>D</sub> (A) | Q <sub>g</sub> (TYP.) |
|---------------------|-----------------------------------|--------------------|-----------------------|
| -30                 | 0.100 at V <sub>GS</sub> = -4.5 V | -1.44              | 8.1 nC                |
|                     | 0.112 at V <sub>GS</sub> = -3.7 V | -1.36              |                       |
|                     | 0.140 at V <sub>GS</sub> = -2.5 V | -1.22              |                       |

SC-89 Single (6 leads)



Top View

Marking Code: C

Ordering Information:

Si1079X-T1-GE3 (Lead (Pb)-free and Halogen-free)

### FEATURES

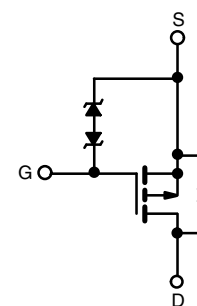
- TrenchFET® power MOSFET
- Typical ESD performance 2500 V
- 100 % R<sub>g</sub> tested
- Material categorization:  
For definitions of compliance please see  
[www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Load switch for portable devices
- Power management



P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)

| PARAMETER                                          | SYMBOL                            | LIMIT                 | UNIT |
|----------------------------------------------------|-----------------------------------|-----------------------|------|
| Drain-Source Voltage                               | V <sub>DS</sub>                   | -30                   | V    |
| Gate-Source Voltage                                | V <sub>GS</sub>                   | ± 12                  |      |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | I <sub>D</sub>                    | -1.44 <sup>b, c</sup> | A    |
|                                                    |                                   | -1.15 <sup>b, c</sup> |      |
| Pulsed Drain Current (t = 300 μs)                  | I <sub>DM</sub>                   | -8                    |      |
| Continuous Source-Drain Diode Current              | I <sub>S</sub>                    | -0.28 <sup>b, c</sup> | W    |
| Maximum Power Dissipation                          | P <sub>D</sub>                    | 0.33 <sup>b, c</sup>  |      |
|                                                    |                                   | 0.21 <sup>b, c</sup>  |      |
| Operating Junction and Storage Temperature Range   | T <sub>J</sub> , T <sub>stg</sub> | -55 to 150            | °C   |

### THERMAL RESISTANCE RATINGS

| PARAMETER                                   | SYMBOL            | TYPICAL | MAXIMUM | UNIT |
|---------------------------------------------|-------------------|---------|---------|------|
| Maximum Junction-to-Ambient <sup>a, b</sup> | R <sub>thJA</sub> | 300     | 375     | °C/W |
|                                             |                   | 360     | 450     |      |

#### Notes

- Maximum under steady state conditions is 450 °C/W.
- Surface mounted on 1" x 1" FR4 board.
- t = 5 s.

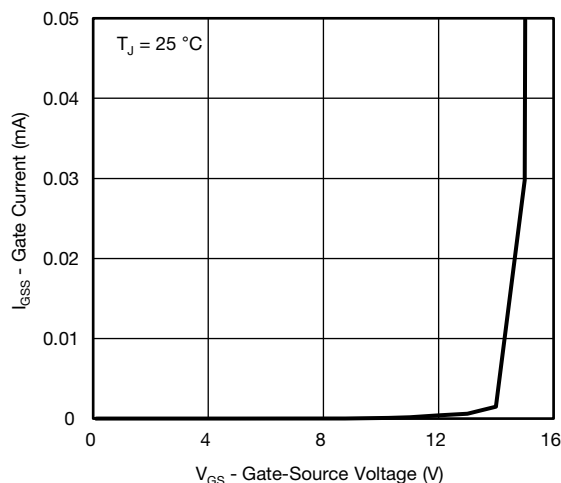
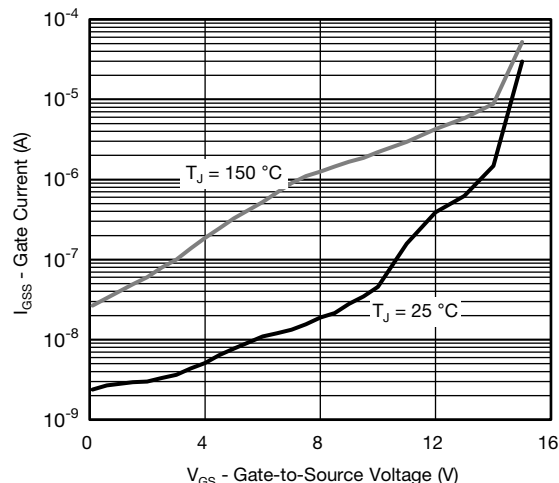
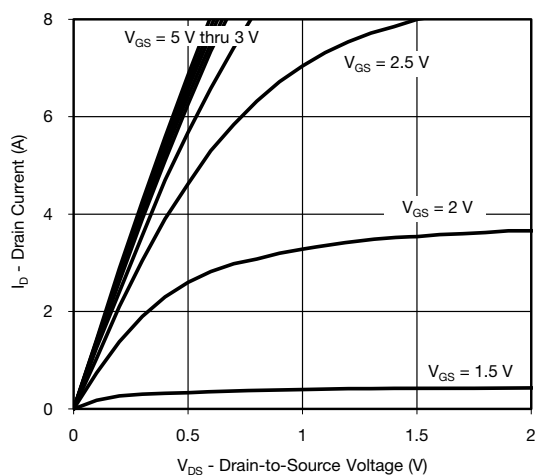
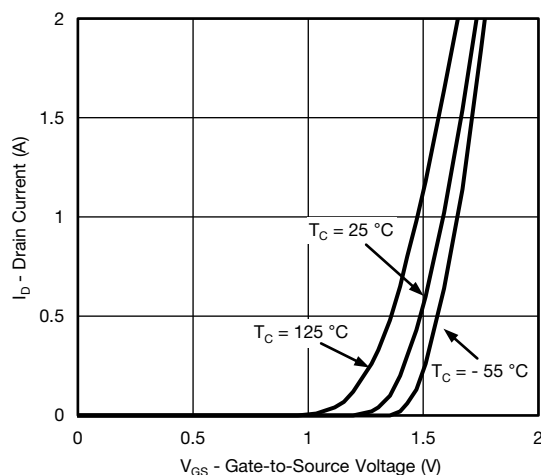
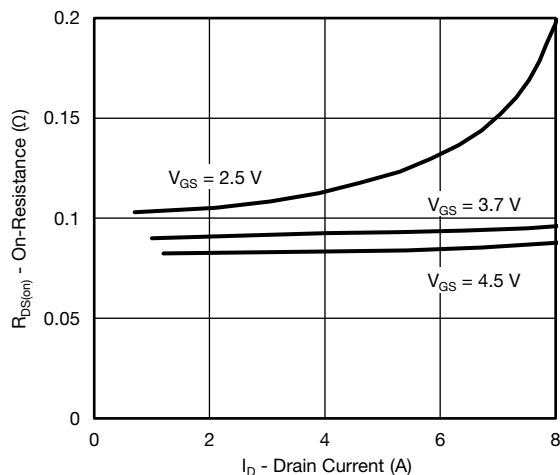
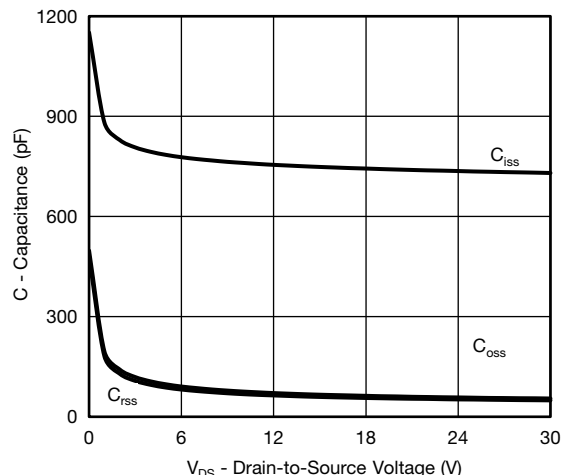


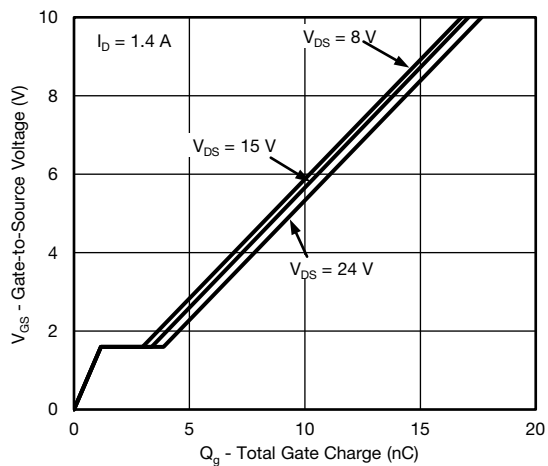
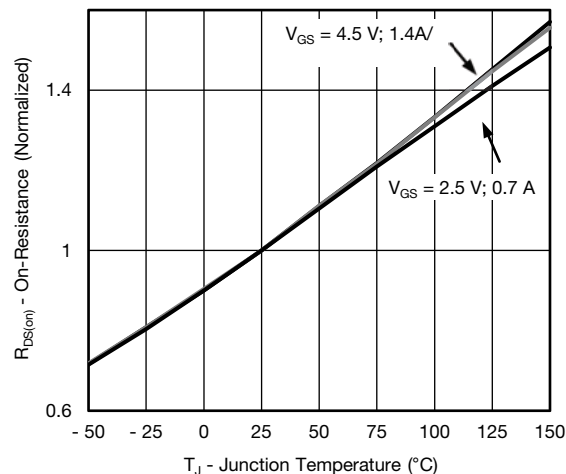
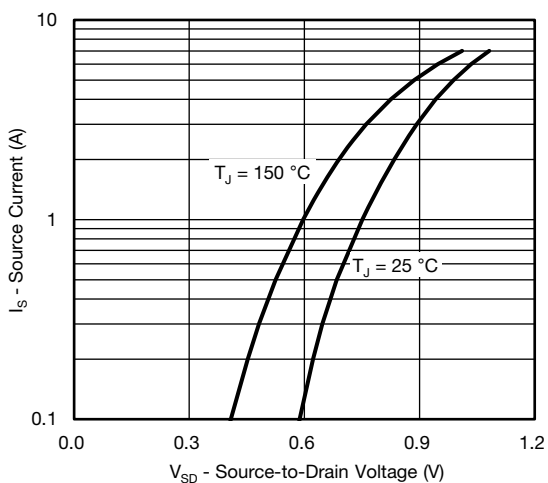
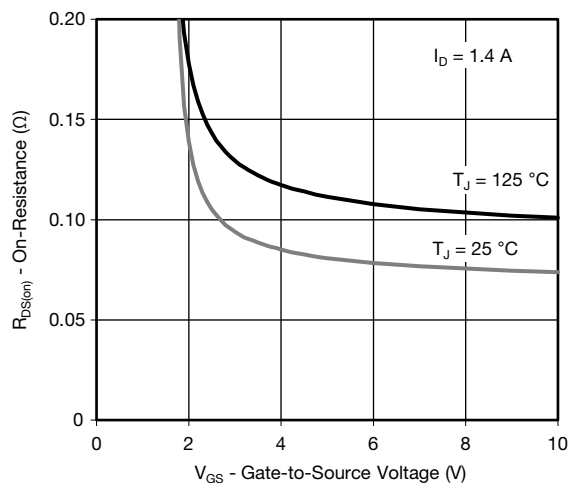
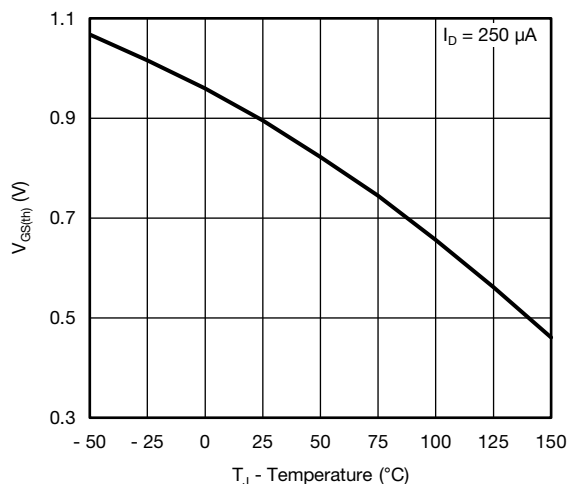
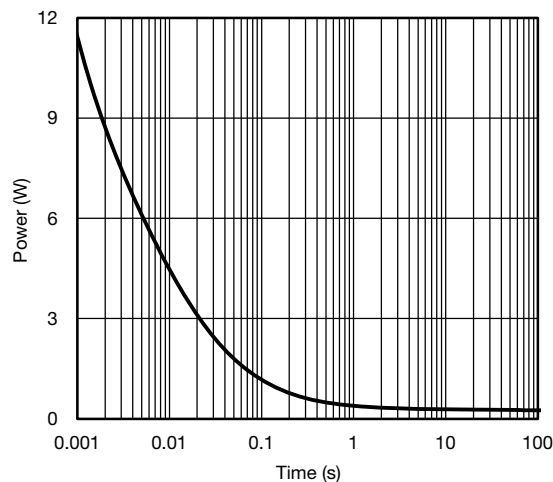
| SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted) |                                      |                                                                                                                             |      |       |       |       |
|-----------------------------------------------------------------|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|------|-------|-------|-------|
| PARAMETER                                                       | SYMBOL                               | TEST CONDITIONS                                                                                                             | MIN. | TYP.  | MAX.  | UNIT  |
| Static                                                          |                                      |                                                                                                                             |      |       |       |       |
| Drain-Source Breakdown Voltage                                  | V <sub>DS</sub>                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA                                                                             | -30  | -     | -     | V     |
| V <sub>DS</sub> Temperature Coefficient                         | ΔV <sub>DS</sub> /T <sub>J</sub>     | I <sub>D</sub> = -250 μA                                                                                                    | -    | -21   | -     | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient                     | ΔV <sub>GS(th)</sub> /T <sub>J</sub> |                                                                                                                             | -    | 3     | -     |       |
| Gate-Source Threshold Voltage                                   | V <sub>GS(th)</sub>                  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA                                                                | -0.6 | -     | -1.5  | V     |
| Gate-Source Leakage                                             | I <sub>GSS</sub>                     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 12 V                                                                             | -    | -     | ± 10  | μA    |
|                                                                 |                                      | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 4.5 V                                                                            | -    | -     | ± 1   |       |
| Zero Gate Voltage Drain Current                                 | I <sub>DSS</sub>                     | V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V                                                                              | -    | -     | -1    |       |
|                                                                 |                                      | V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C                                                      | -    | -     | -10   |       |
| On-State Drain Current <sup>a</sup>                             | I <sub>D(on)</sub>                   | V <sub>DS</sub> = ≥ -5 V, V <sub>GS</sub> = -4.5 V                                                                          | -8   | -     | -     | A     |
| Drain-Source On-State Resistance <sup>a</sup>                   | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -1.4 A                                                                           | -    | 0.083 | 0.100 | Ω     |
|                                                                 |                                      | V <sub>GS</sub> = -3.7 V, I <sub>D</sub> = -1.3 A                                                                           | -    | 0.093 | 0.112 |       |
|                                                                 |                                      | V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -0.7 A                                                                           | -    | 0.108 | 0.140 |       |
| Forward Transconductance                                        | g <sub>fs</sub>                      | V <sub>DS</sub> = -15 V, I <sub>D</sub> = -1.4 A                                                                            | -    | 10    | -     | S     |
| Dynamic <sup>b</sup>                                            |                                      |                                                                                                                             |      |       |       |       |
| Input Capacitance                                               | C <sub>iss</sub>                     | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz                                                                   | -    | 750   | -     | pF    |
| Output Capacitance                                              | C <sub>oss</sub>                     |                                                                                                                             | -    | 67    | -     |       |
| Reverse Transfer Capacitance                                    | C <sub>rss</sub>                     |                                                                                                                             | -    | 60    | -     |       |
| Total Gate Charge                                               | Q <sub>g</sub>                       | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -1.4 A                                                   | -    | 17    | 26    | nC    |
|                                                                 |                                      | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -1.4 A                                                  | -    | 8.1   | 13    |       |
| Gate-Source Charge                                              | Q <sub>gs</sub>                      |                                                                                                                             | -    | 1.2   | -     |       |
| Gate-Drain Charge                                               | Q <sub>gd</sub>                      |                                                                                                                             | -    | 2.2   | -     |       |
| Gate Resistance                                                 | R <sub>g</sub>                       | f = 1 MHz                                                                                                                   | 3.6  | 18    | 36    | Ω     |
| Turn-On Delay Time                                              | t <sub>d(on)</sub>                   | V <sub>DD</sub> = -15 V, R <sub>L</sub> = 13 Ω<br>I <sub>D</sub> ≅ -1.15 A, V <sub>GEN</sub> = -4.5 V, R <sub>g</sub> = 1 Ω | -    | 22    | 33    | ns    |
| Rise Time                                                       | t <sub>r</sub>                       |                                                                                                                             | -    | 33    | 50    |       |
| Turn-Off Delay Time                                             | t <sub>d(off)</sub>                  |                                                                                                                             | -    | 58    | 87    |       |
| Fall Time                                                       | t <sub>f</sub>                       |                                                                                                                             | -    | 30    | 45    |       |
| Turn-On Delay Time                                              | t <sub>d(on)</sub>                   | V <sub>DD</sub> = -15 V, R <sub>L</sub> = 13 Ω<br>I <sub>D</sub> ≅ -1.15 A, V <sub>GEN</sub> = -10 V, R <sub>g</sub> = 1 Ω  | -    | 5     | 10    |       |
| Rise Time                                                       | t <sub>r</sub>                       |                                                                                                                             | -    | 20    | 30    |       |
| Turn-Off Delay Time                                             | t <sub>d(off)</sub>                  |                                                                                                                             | -    | 80    | 120   |       |
| Fall Time                                                       | t <sub>f</sub>                       |                                                                                                                             | -    | 30    | 45    |       |
| Drain-Source Body Diode Characteristics                         |                                      |                                                                                                                             |      |       |       |       |
| Pulse Diode Forward Current <sup>a</sup>                        | I <sub>SM</sub>                      |                                                                                                                             | -    | -     | -8    | A     |
| Body Diode Voltage                                              | V <sub>SD</sub>                      | I <sub>S</sub> = -1.15 A                                                                                                    | -    | -0.75 | -1.2  | V     |
| Body Diode Reverse Recovery Time                                | t <sub>rr</sub>                      | I <sub>F</sub> = -1.15 A, dI/dt = 100 A/μs                                                                                  | -    | 16    | 24    | ns    |
| Body Diode Reverse Recovery Charge                              | Q <sub>rr</sub>                      |                                                                                                                             | -    | 7     | 14    | nC    |
| Reverse Recovery Fall Time                                      | t <sub>a</sub>                       |                                                                                                                             | -    | 9     | -     | ns    |
| Reverse Recovery Rise Time                                      | t <sub>b</sub>                       |                                                                                                                             | -    | 7     | -     |       |

**Notes**

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.

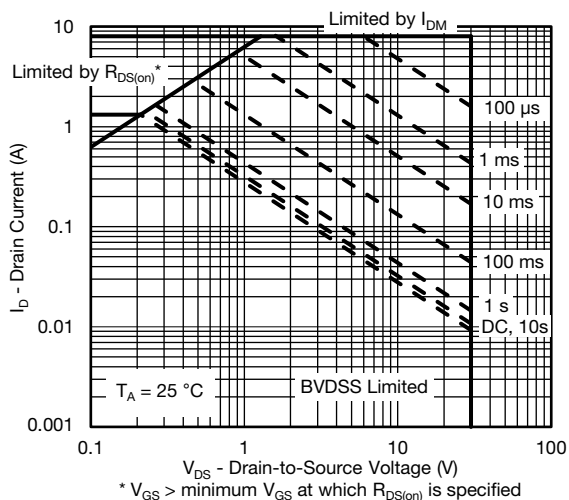
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**Gate Current vs. Gate-Source Voltage**

**Gate Current vs. Gate-to-Source Voltage**

**Output Characteristics**

**Transfer Characteristics Curves vs. Temperature**

**On-Resistance vs. Drain Current**

**Capacitance**

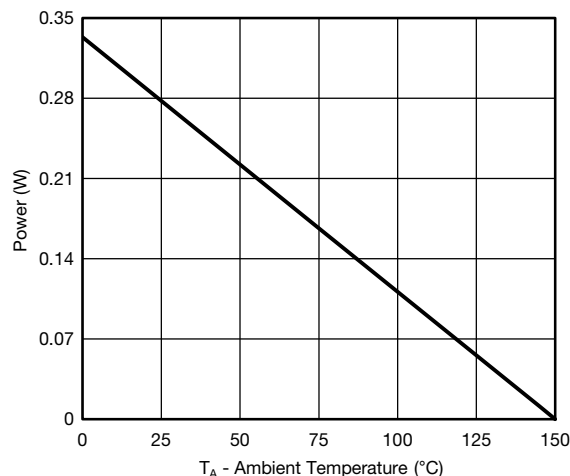
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**Gate Charge**

**On-Resistance vs. Junction Temperature**

**Source-Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Single Pulse Power, Junction-to-Ambient**



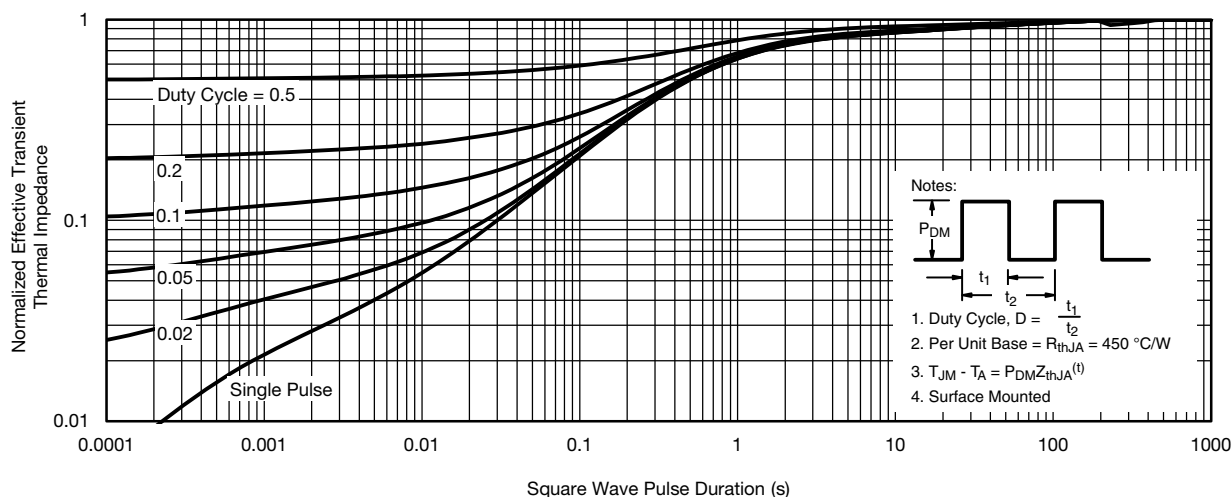
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)



**Safe Operating Area, Junction-to-Ambient**



**Power Junction-to-Ambient**

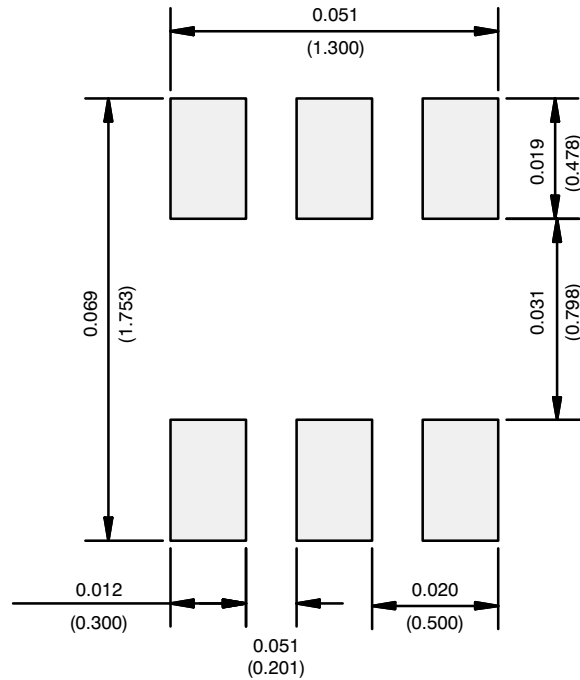


**Normalized Thermal Transient Impedance, Junction-to-Ambient**

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## RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads  
Dimensions in Inches/(mm)

[Return to Index](#)



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